

Technical slides



### **Applications/Verticals**

- High AI performance requirement OEM machine
- Design for Machine vision Al use case
- Optimized for Industrial embedded AI



### **Key features**

- Compact size with diverse interfaces and expansion options
- Excellent price/performance ratio for cost-efficient implementation
- Industrial OS advanced experience





#### **Performance**

- Processor upgrade with latest NVIDIA Jetson Orin technology
- 12-24V wide range PSU
- 4x PoE for machine vision



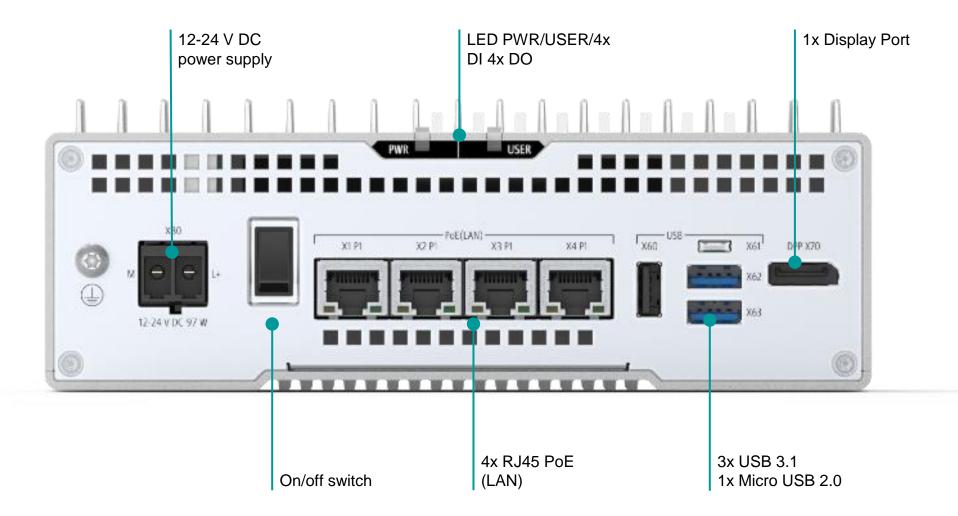
## Flexibility & Scalability

FLEX MODULE for different IO expansion will bring more opportunities – under development



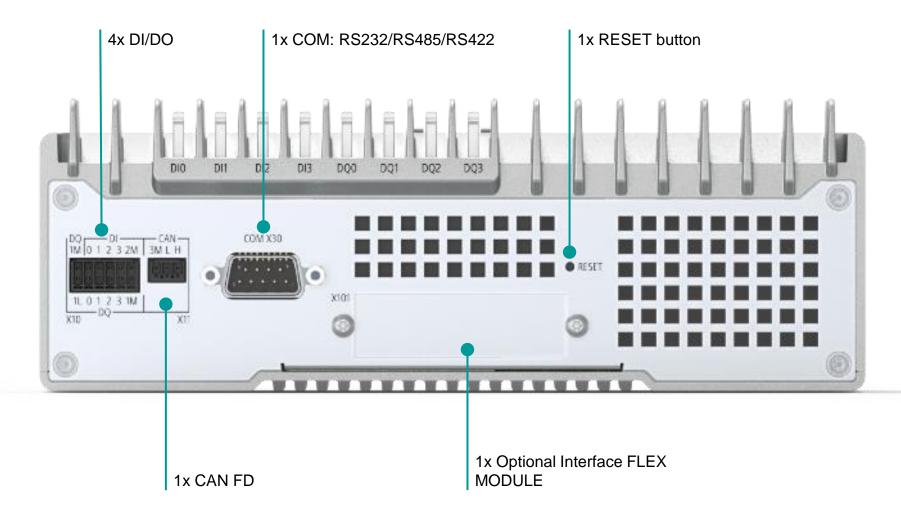


# Overview of front panel





# Overview of back panel





# Overview of side face





# Technical specifications

## Design

	Jetson™ Orin NX 16GB version	Jetson™ Orin NX 8GB version
Processor	8-core Arm® Cortex®-A78AE v8.2 64-bit CPU MB L2 + 4MB L3	6-core Arm® Cortex®-A78AE v8.2 64-bit CPU 1.5MB L2 + 4MB L3
Main memory	16GB 128-bit LPDDR5 102.4GB/s	8GB 128-bit LPDDR5 102.4GB/s
Chipset	Jetson Orin NX 16GB	Jetson Orin NX 8GB
Graphics	1024-core NVIDIA Ampere architecture GPU with 32 Tensor Cores	
Operating system	<ul> <li>NVIDIA® JetPack 5.1.2 for developing purpose</li> <li>Industrial OS V3.4 based on JetPack 5.1.2</li> </ul>	
Power supply	<ul><li>DC rated 12-24 V, range 9-36 V</li><li>on/off switch</li></ul>	





# **Technical specifications**

Design		
M.2 NVMe SSD	NA or 256GB or 512GB or 1TB	
Interfaces		
СОМ	1 x RS232/RS422/RS485, max. 115 Kbps, D-sub connector, 9-pin	
USB	3x USB 3.1 Gen1 Type A	
	1x USB 2.0 Micro USB	
Ethernet	4x Gbe RJ45 with PoE function	
Graphics	1x display port (DP1.4 capable, up to 4kp60)	
Digital I/O	• 4x DI	
	• 4x DO	
CAN BUS	1x CAN FD	
Layout	Interfaces on front and back panel	





# Technical specifications

### **Expandability**

**Expansion slots** 

#### 1 x Nano SIM card slot

#### 3 x M.2 expansion slot

- 1x M.2 2230 (E Key)
- 1x M.2 2242/3042/52/60 (B Key)
- 1x M.2 2242/2280 (M Key)

#### Support 1x FLEX MODULE (optional accessory) – under development

- M.2 to 4x COM
- M.2 to 24ch GPIO
- M.2 to 2x LAN
- M.2 to 2x USB3.2





# Technical specifications

### **Mounting options**

Types of installation

• Mounting on a DIN rail
• Wall mounting

#### **Accessories**

Mounting accessory kit	<ul> <li>One standard rail bracket</li> <li>Two wall mounting brackets</li> </ul>
Accessory kit	<ul> <li>One DC connecting terminal block</li> <li>One CAN plug</li> <li>One DI/DQ plug</li> <li>Six M3 screws</li> </ul>

#### **Dimensions**

Basic unit  $W \times H \times D = approx. 196 \times 131 \times 69 \text{ mm}$ 





# **Technical specifications**

#### **Ambient conditions**

Vibration	Operation, Up to 1g@8.4-200Hz, according to IEC 60068-2-6	
Shock	Operation, Up to 15g@11ms, according to IEC 60068-2-27	
Ambient temperature during operation	<ul> <li>15W CPU, 30W PoE, 3W M.2 B key and E key module: 0°C to 50°C</li> <li>25W CPU, 15W PoE: 0°C to 40°C</li> </ul>	
Protection class according to EN 60529	IP20	
Approvals	• CE • UL • FCC	<ul><li>KCC</li><li>RCM</li><li>Etc.</li></ul>
Power consumption	Max. 97 W	





## Migration SIMATIC IPC520A to IPC BX-35A

Installation compatibility	IPC520A	IPC BX-35A
Enclosure dimensions	W x H x D = approx. 234 mm x 129 mm x 71 mm	W x H x D = approx. 196 x 131 x 69 mm
Mounting options	Wall mounting, mounting on DIN rails	Wall mounting, mounting on DIN rails

## Interface compatibility

Expansion (internal)	1x B-key,1x E-key	1x M-key, 1x B-key, 1x E-key
Expansion (internal)	TA B-Rey, TA E-Rey	17 W-Rey, 17 B-Rey, 17 E-Rey
Ethernet interfaces	4x LAN (2x POE)	4x LAN (4x POE)
Graphics interface	1x DP	1x DP (support DP++)
USB ports	3x USB 3.1 Type A, 1x Micro USB 2.0	3x USB 3.1 Type A, 1x Micro USB 2.0
Serial ports	1x COM RS485/422/232	1x COM RS485/422/232
Digital I/O	4x DI, 2x DO	4x DI, 4x DO
CAN	NA	1x CAN FD
Expansion (External)	NA	1x FLEX MODULE (Optional)





# Migration SIMATIC IPC520A to IPC BX-35A

	IPC520A	IPC BX-35A
System compatibili	ty	
Nvidia SOM	Nvidia <sup>®</sup> Jetson™ Xavier 16G	Nvidia <sup>®</sup> Jetson™ Orin 16G/8G
NVME Storage	256G SSD (single PCIE lane)	Up to 1T SSD (4 PCIE lanes)
Software compatibi	ility	
Nvidia JetPack	Start from Nvidia® JetPack 5.0.2	Start from Nvidia® JetPack 5.1.2
Operating system	Industrial OS 3.4	Industrial OS 3.4





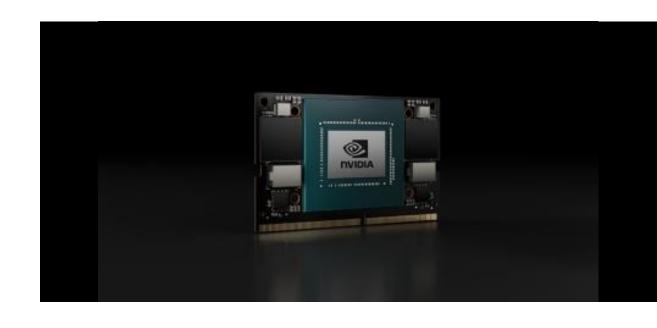
#### **SIMATIC IPC BX-35A extensions**

#### M.2 Modules/COM interfaces

## Jetson Orin NX Series

Jetson Orin NX modules deliver up to 100 TOPS of AI performance in the smallest Jetson form factor, with power configurable between 10W and 25W. This gives you up to 3X the performance of Jetson AGX Xavier and up to 5X the performance of Jetson Xavier NX. Jetson Orin NX is available in 16GB and 8GB versions.





#### Other Functionalities

#### **FLEX MODULE**

E.g., additional USB/COM/LAN/GPIO



#### **Radio communication**

- M.2 extension for WiFi/BT, or 4G/5G modules
- Antenna position reserved for better signal

#### **Industrial OS**

To optimize the industrial Al-Accelerator and security



# Use the best performance in its class

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